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NAND Fabrication Site Transfer for 32Gb MLC NAND Flash (L83A)

PCN: 32182

Published: 2017-01-03

Type:	Manufacturing Site – Change or Addition
Description:	Micron's 20nm 32Gb MLC NAND (L83A) will transfer from Fab 10 (Singapore) to Fab 6 (Manassas, Virginia).
Reason:	Manufacturing Efficiency, Supply Flexibility/Security
Product Affected:	20nm 32Gb MLC NAND (L83A)

Affected Micron Part Number	Recommended Replacement	Customer Part Number
<u>Component</u>		
MT29F32G08CBADAL83A3WC1-M		
MT29F32G08CBADAWP:D		557-1670-2-ND
MT29F32G08CBADAWP-M:D		
MT29F32G08CBADBWP-12IT:D		
MT29F32G08CBADBWPR:D		
<u>Die</u>		
MT29F32G08CBADAL83A3WC1		
MT29F32G08CBEDBL83A3WC1		

*Materials that have been ordered are in **bold**.

Method of Identification: Refer to Micron's Customer Service Note CSN-11 (Product Marks, Product Labels, and Packaging Labels): "Fab 6" will appear on the inner packing container label.

Micron Sites Affected: Fab 6 – US

Sample Available: 2017-02-21

Qual Data Available: 2017-02-21

Product Ship Date: 2017-04-03

NOTE: Per JEDEC Standard JESD46-C Section 3.2.3; lack of acknowledgment of this PCN within 30 days constitutes acceptance of change.

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Thank you

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